ABSOCIATION CONNECTING LECTRONICS INDUSTNESS INDUSTNESS	PC. Bannockł	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s encompasse	ubstances es all lowe	within the n r level mate	nanufacture rials for wh	er listed ite nich the ma	m. Note: i nufacturer	if the item is an as r has engineering	sembly with lowe responsibility.
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					ous Materia	als and Mfg Information			
Supplier Information														
Company name* Co			Company unique ID			Unique ID Authority					Response Date*			
onsemi								2025			2025-09-3	025-09-10		
Contact Name Title - Contact					Phone - Contact*						Email - Contact*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - F			le - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Num		Number Mfr Item Name			Effective Dat	tive Date Version Manufacturing Site		ng Site	W	'eight*	UOM	Unit Type	
	FDBL94	FDBL9403-F085 NMOS TOLL 40		V 1.2 mOhm	2 mOhm 20			]	РВВ		8	1.7391	mg	Each
Manufacturing Proccess Informa	tion							<u>,</u>						
Terminal Plating / Grid Array M	Iaterial Terminal Base Allo		Alloy	J-STD-020 MSI	D-020 MSL Rating		Peak Process Body Temperature		re Max Time at Peak Temper		Temperatu	re Numb	per of Reflow Cy	cles
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30		second	s 3		
Comments														
evel 1 - maximum time at peak temperat	ure during so	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et						
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	6.35	mg	Supplier	Silicon (Si)	7440-21-3		6.35	mg	
Die Attach Solder	7.6901	mg	Supplier	Silver (Ag)	7440-22-4		0.1923	mg	
			А	Lead (Pb)	7439-92-1	7a	7.344	mg	
			Supplier	Tin (Sn)	7440-31-5		0.1538	mg	
Lead Frame	474.555	mg	В	Nickel (Ni)	7440-02-0		0.2373	mg	
			Supplier	Iron (Fe)	7439-89-6		0.4746	mg	
			Supplier	Copper (Cu)	7440-50-8		473.7008	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.1424	mg	
Mold Compound-Black	314.85	mg		Epoxy resin	proprietary data		41.875	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.6297	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		272.3452	mg	
Plating	8.12	mg	Supplier	Tin (Sn)	7440-31-5		8.12	mg	
Wire Bond - Al	0.174	mg	Supplier	Aluminum (Al)	7429-90-5		0.174	mg	